

*IFW*  
843.40341CX1



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Y. SAITO et al  
Serial No.: 10/764,539  
Filed: January 27, 2004  
For: SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP, AND MANUFACTURING METHOD OF SEMICONDUCTOR CHIP  
Group: 2811  
Examiner: T. NGUYEN

**PRELIMINARY AMENDMENT**

**MS: PATENT APPLICATIONS**

Commissioner for Patents  
POB 1450  
Alexandria, VA 22313-1450

April 30, 2004

Sir:

Please amend the above-identified application as listed below and as set forth on the following pages:

**Amendment to the Specification.**

**Amendments to the Claims.**

**Remarks** are included following the Amendments.